

## PATENT ASSIGNMENT

Electronic Version v08

Stylesheet Version v02

SUBMISSION TYPE:	NEW ASSIGNMENT	<b>APPLICATION NUMBER</b> 11/163997															
NATURE OF CONVEYANCE:	ASSIGNMENT OF ASSIGNOR'S INTEREST																
CONVEYING PARTY DATA																	
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>KAHP-YANG SUH</td><td>2005-10-24</td></tr><tr><td>HOON-EUI JEONG</td><td>2005-10-24</td></tr></tbody></table>						Name	Execution Date	KAHP-YANG SUH	2005-10-24	HOON-EUI JEONG	2005-10-24						
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SEOUL NATIONAL UNIVERSITY INDUSTRY FOUNDATION	San 4-2, Bongcheon-dong, Gwanak-gu		Seoul	REPUBLIC OF KOREA													
CORRESPONDENCE DATA																	
FAX NUMBER: 2136370132																	
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>																	
When the customer number has been provided, the Office of Public Records will obtain the correspondence data from the official record on file at the USPTO.																	
CUSTOMER NUMBER: 052706																	
NAME OF PERSON SIGNING:		James E. Bame															
DATE SIGNED:		2005-11-07															
Total Attachments: 1 source=2034-01assignment.tif																	

CH \$40.00 503566 11163997

# A S S I G N M E N T

WHEREAS, I/WE, **KAHP-YANG SUH**, residing at A122-403 Seoul National Univ Kyosu Apt., San 4-2, Bongcheon 7-dong, Gwanak-gu, Seoul, Republic of Korea, and **HOON-EUI JEONG**, residing at 112-1308 Doosan Apt., Gasan-dong, Geumcheon-gu, Seoul, Republic of Korea, hereafter, together with any successors, legal representatives or assigns thereof, referred to as "Applicant", invented certain new and useful improvements disclosed in an application for United States Letters Patent titled "**METHOD FOR FORMING NANOSTRUCTURE HAVING HIGH ASPECT RATIO AND METHOD FOR FORMING NANOPATTERN USING THE SAME**" executed on even date herewith;

AND WHEREAS, **SEOUL NATIONAL UNIVERSITY INDUSTRY FOUNDATION**, whose mailing address is SAN 4-2 BONGCHEON-DONG, GWANAK-GU, SEOUL, REPUBLIC OF KOREA, hereafter, together with any successors, legal representatives or assigns thereof, referred to as "Assignee", want(s) to acquire the entire right, title and interest in and to said improvements and application;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, Applicant has sold, assigned, transferred and set over, and do hereby sell, assign, transfer and set over to Assignees the entire right, title and interest in and to said improvements, and said application and all divisions, substitutions, continuations and continuations-in-part thereof, and all United States Letters Patents (and all other patents) which may be granted thereon and all reissues and extensions thereof, and all priority rights under the International Convention for the Protection of Industrial Property for every member country, and all applications for patents (including related rights such as utility-model registrations, inventor's certificates, and the like) heretofore or hereafter filed for said improvements in any foreign countries, and all patents (including all extensions, renewals and reissues thereof) granted for said improvements in any foreign countries; and Applicant hereby authorize and request the United States Commissioner of Patents and Trademarks, and any officials of foreign countries whose duty is to issue patents on applications as aforesaid, to issue all patents for said improvements to Assignees in accordance with the terms of this assignment;

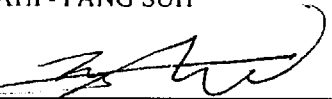
AND APPLICANT HEREBY covenants that Applicant has full right to convey the entire interest herein assigned, and that Applicant has not executed, and will not execute, any agreement in conflict herewith;

AND APPLICANT HEREBY further covenants and agrees that Applicant will communicate to Assignees any facts known to us respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional continuation, continuations legal proceeding, sign all lawful papers, execute all divisional, continuation, continuations-in-part, substitute and reissue applications, make all rightful oaths and generally do everything possible to aid Assignees to obtain and enforce proper patent protection for said improvements in all countries.

Date: 10/24/05

Signature:   
KAHP-YANG SUH

Date: 10/24/05

Signature:   
HOON-EUI JEONG

STATE OF \_\_\_\_\_ )

SS:

COUNTY OF \_\_\_\_\_ )

Before me personally appeared said KAHP-YANG SUH & HOON-EUI JEONG, and acknowledged the foregoing instrument to be his free act and deed on this \_\_\_\_\_ day of \_\_\_\_\_, 2005.

Seal

PATENT

RECORDED: 11/07/2005

REEL: 016741 FRAME: 0160